

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Toshikazu Mochizuki	10/15/2009
RECEIVING PARTY DATA	
Name:	Hakko Corporation
Street Address:	4-5, Shiokusa 2-chome, Naniwa-ku, Osaka-shi
City:	Osaka
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12600255
CORRESPONDENCE DATA	
Fax Number: (415)393-9887 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 415-393-9866 Email: dperegory@ssd.com Correspondent Name: Squire Sanders & Dempsey LLP Address Line 1: One Maritime Plaza Address Line 2: Suite 300 Address Line 4: San Francisco, CALIFORNIA 94111	
ATTORNEY DOCKET NUMBER:	062649.00045
NAME OF SUBMITTER:	Norman Morales (Reg. 55,463)
Total Attachments: 1 source=62649.45Assign#page1.tif	

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PATENT
 REEL: 023524 FRAME: 0095

ASSIGNMENT

For value received, I, Toshikazu MOCHIZUKI, residing at c/o Hakko Corporation, 4-5, Shiokusa 2-chome, Naniwa-ku, Osaka-shi, Osaka, Japan, hereby sell, assign, and transfer to **HAKKO CORPORATION**, a corporation existing under the laws of Japan, located at 4-5, Shiokusa 2-chome, Naniwa-ku, Osaka-shi, Osaka, Japan, and its successors, assigns, and legal representatives, the entire right, title, and interest for all countries including the United States of America, in and to certain inventions relating to

**SOLDER HANDLING TEMPERATURE CONTROLLER
WITH TEMPERATURE LOCK MECHANISM**

described in an application for Letters Patent of the United States,

☒ having an oath or declaration by me/us executed on even date herewith;

☐ bearing Serial No. 12/600,255 and filed on November 13, 2009,

and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I/We have full right so to do, and agree that I/We will communicate to said Company or its representatives any facts known to me/us respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

The Assignor(s) hereby authorizes and requests the attorneys of SQUIRE SANDERS & DEMPSEY, L.L.P., to insert in the spaces provided above the filing date, serial number, and attorney docket number of said application if not previously inserted.

Signature Toshikazu Mochizuki Date Oct. 15, 2009
Toshikazu MOCHIZUKI